LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司



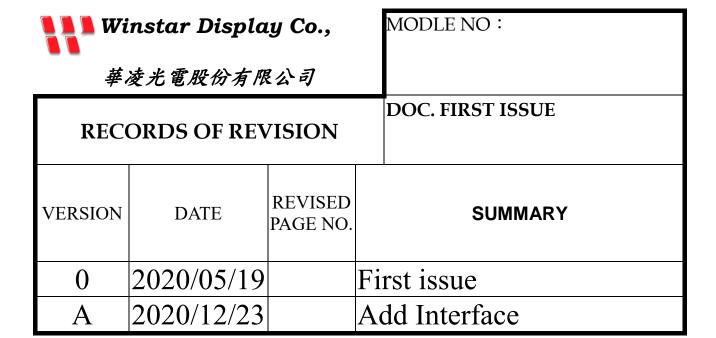
WEB: https://www.winstar.com.tw E-mail: sales@winstar.com.tw

SPECIFICATION

MODULE NO.:	WO12864K	1- TMI #
APPROVED BY: (FOR CUSTOMER USE ONLY)	PCB VERSION:	DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
A	2020/12/23		Add Interface



Contents

- 1.Module Classification Information
- 2.Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7.Interface Pin Function
- 8. Contour Drawing
- 9.Reliability
- 10.Backlight Information
- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage

1. Module Classification Information

- ① Brand: WINSTAR DISPLAY CORPORATION
- ② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type
- ③ Display Font: 128 * 64 dot
- Model serials no.
- \bigcirc Backlight Type: N \rightarrow Without backlight T \rightarrow LED, White L \rightarrow LED, Full color

 $B\rightarrow EL$, Blue green $A\rightarrow LED$, Amber $J\rightarrow DIP$ LED, Blue $D\rightarrow EL$, Green $R\rightarrow LED$, Red $K\rightarrow DIP$ LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

 $M\rightarrow$ EL, Yellow Green $G\rightarrow$ LED, Green $H\rightarrow$ DIP LED, Amber $F\rightarrow$ CCFL, White $P\rightarrow$ LED, Blue $I\rightarrow$ DIP LED, Red

 $Y \rightarrow LED$, Yellow Green $X \rightarrow LED$, Dual color $G \rightarrow LED$, Green $C \rightarrow LED$, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$ Positive, Gray $F \rightarrow FSTN$ Positive $I \rightarrow HTN$ Negative, Black $K \rightarrow FSC$ Negative $U \rightarrow HTN$ Negative, Blue $S \rightarrow FSC$ Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

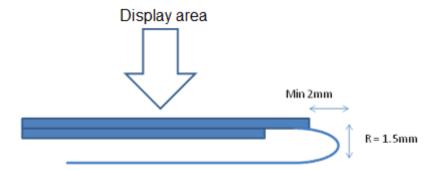
Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00 direction J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00 E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code #:Fit in with the ROHS Directions and regulations

2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11) The limitation of FPC bending



(12)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

3.General Specification

Item	Dimension	Unit				
Number of dots	128 x 64	_				
Module dimension	89.7 x 49.8 x 6.0	mm				
View area	66.8 x 35.5	mm				
Active area	63.98 x 31.98	mm				
Dot size	0.48 x 0.48	mm				
Dot pitch	0.50x 0.50 mm					
LCD type	STN Negative, Blue Transmissive (In LCD production, It will occur slightly coonly guarantee the same color in the same be	(In LCD production, It will occur slightly color difference. We can				
Duty	1/65duty , 1/9 Bias					
View direction	6 o'clock	6 o'clock				
Backlight Type	LED ,White					
IC	ST7565P					
Interface	6800/8080/4-Line SPI					

4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	Тор	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Power Supply Voltage	VDD	-0.3	_	3.6	V
Power supply voltage (VDD standard)	V0, VOUT	-0.3	_	14.5	V
Power supply voltage (VDD standard)	V1, V2, V3, V4	-0.3	_	V0+0.3	V

5.Electrical Characteristics

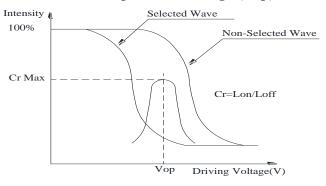
Item Symbol Condition		Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V_{DD} - V_{SS}	_	2.8	3.0	3.2	V
		Ta=-20°C	_	_	_	V
Supply Voltage For LCD	V_{OP}	Ta=25°C	9.3	9.5	9.7	V
*Note		Ta=70°C	_	_	_	V
Input High Volt.	$ m V_{IH}$	_	$0.8~\mathrm{V_{DD}}$	_	$V_{ m DD}$	V
Input Low Volt.	V_{IL}	_	V _{SS}	_	$0.2~\mathrm{V_{DD}}$	V
Output High Volt.	V_{OH}	_	$0.8~\mathrm{V_{DD}}$	_	$V_{ m DD}$	V
Output Low Volt.	V _{OL}	_	V_{SS}	_	$0.2~\mathrm{V_{DD}}$	V
Supply Current	I_{DD}	V _{DD} =3.0V	_	_	2.0	mA

Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance

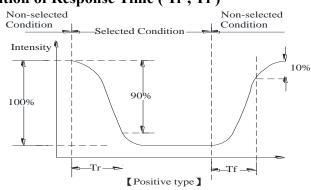
6.Optical Characteristics

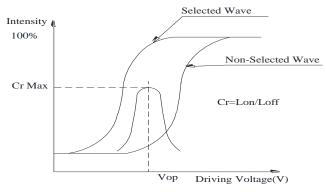
Item	Symbol	Condition	Min	Тур	Max	Unit
	heta	CR≧2	0	_	20	$\phi = 180^{\circ}$
X7: A1 -	θ	CR≧2	0	_	40	$\phi = 0^{\circ}$
View Angle	θ	CR≧2	0	_	30	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	30	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	3	_	_
Response Time	T rise	_	—	200	300	ms
	T fall	_	_	250	350	ms

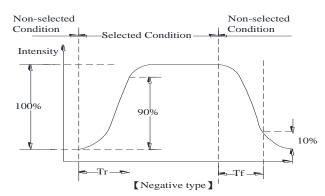
Definition of Operation Voltage (Vop)



Definition of Response Time (Tr, Tf)





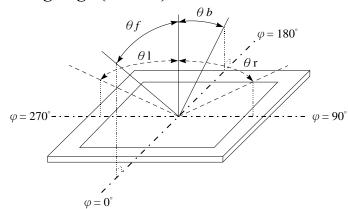


Conditions:

Operating Voltage: Vop Frame Frequency: 64 HZ Viewing Angle(θ , φ): 0° , 0°

Z Driving Waveform: 1/N duty, 1/a bias

Definition of viewing angle(CR≥2)



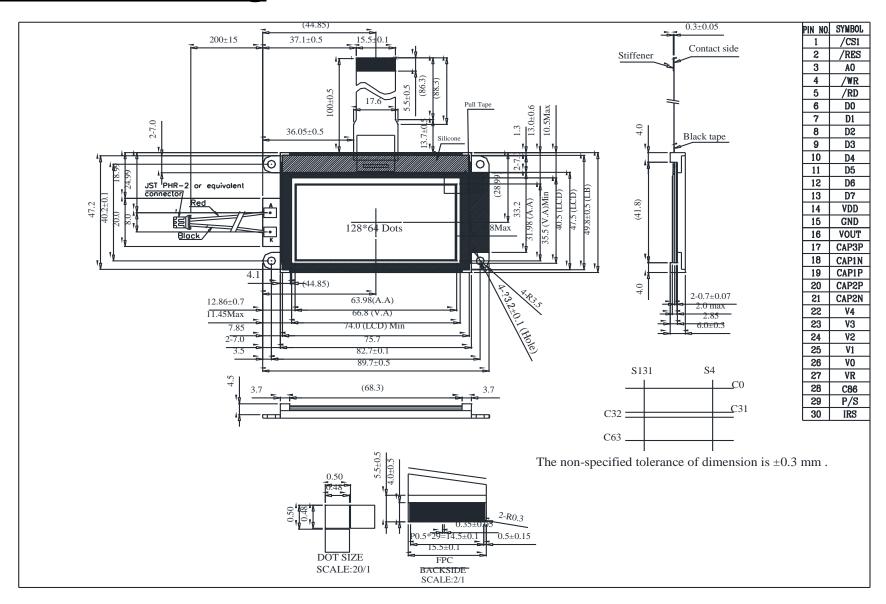
7.Interface Pin Function

Pin No.	Symbol	Description				
1	/CS1	This is the chip select signal. When /CS1 = "L" and CS2 = "H", then the chip select becomes active, and data/command I/O is enabled.				
2	/RES	When /RES is set to "L", the register settings are initialized (cleared). The reset operation is performed by the /RES signal level.				
3	A0	This is connect to the least significant bit of the normal MPU address bus, and it determines whether the data bits are data or command. A0 = "H": Indicates that D0 to D7 are display data. A0 = "L": Indicates that D0 to D7 are control data.				
4	/WR	 When connected to 8080 series MPU, this pin is treated as the "/WR" signal of the 8080 MPU and is LOW-active. The signals on the data bus are latched at the rising edge of the /WR signal. When connected to 6800 series MPU, this pin is treated as the "R/W" signal of the 6800 MPU and decides the access type: When R/W = "H": Read. When R/W = "L": Write. 				
5	/RD	 When connected to 8080 series MPU, this pin is treated as the "/RD" signal of the 8080 MPU and is LOW-active. The data bus is in an output status when this signal is "L". When connected to 6800 series MPU, this pin is treated as the "E" signal of the 6800 MPU and is HIGH-active. This is the enable clock input terminal of the 6800 Series MPU. 				
6	D0					
7	D1	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit				
8	D2	standard				
9	D3	MPU data bus. When the social interface (SDL4) is selected (D/S = "L"):				
10	D4	When the serial interface (SPI-4) is selected (P/S = "L"): D7: serial data input (SI); D6: the serial clock input (SCL). D0 to D5 should				
11	D5	be connected to VDD or floating.				
12	D6	When the chip select is not active, D0 to D7 are set to high impedance.				
13	D7					
14	VDD	Power supply Power supply				
15	GND	Ground				
16	VOUT	DC/DC voltage converter. Connect a capacitor between this terminal and VSS or VDD				

17	CAP3+		DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1N terminal.					
18	CAP1-		DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1P terminal.					
19	CAP1+		voltage converterminal.	rter. Conne	ect a capaci	tor between	this terminal and the	
20	CAP2+		voltage converterminal.	rter. Conne	ect a capaci	tor between	this terminal and the	
21	CAP2-		voltage converterminal.	rter. Conne	ect a capaci	tor between	this terminal and the	
22	V4		-		•		drive. The voltage and is changed through	
23	V3	the use	of a resistive vo	oltage divi	ded or thro	ugh changi	ng the impedance using	
24	V2	relative	an op. amp. Voltage levels are determined based on Vss, and must maintain the relative magnitudes shown below.					
25	V1	When th	$V0 \ge V1 \ge V2 \ge V3 \ge V4 \ge Vss$ When the power supply turns ON, the internal power supply circuits produce the					
26	V0		4 voltages show as set command		The voltage	e settings a	re selected using the	
27	VR	through IRS = "	Output voltage regulator terminal. Provides the voltage between VSS and V0 through a resistive voltage divider. IRS = "L": the V0 voltage regulator internal resistors are not used. IRS = "H": the V0 voltage regulator internal resistors are used.					
28	C86		This is the MPU interface selection pin. C86 = "H": 6800 Series MPU interface. C86 = "L": 8080 Series MPU interface.					
29	P/S	This pin configures the interface to be parallel mode or serial mode. P/S = "H": Parallel data input/output. P/S = "L": Serial data input. The following applies depending on the P/S status: P/S Data/Command Data Read/Write Serial Clock "H" A0 D0 to D7 /RD, /WR X "L" A0 SI (D7) Write only SCL (D6) When P/S = "L", D0 to D5 must be fixed to "H".						
		/RD (E) and /WR (R/W) are fixed to either "H" or "L". The serial access mode does NOT support read operation.						

		This terminal selects the resistors for the V0 voltage level adjustment.
30	IRS	IRS = "H": Use the internal resistors IRS = "L": Do not use the internal resistors. The V0 voltage level is
		regulated by an external resistive voltage divider attached to the VR terminal

8.Contour Drawing



9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test					
Test Item	Content of Test	Test Condition	Not e			
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2			
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2			
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	_			
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1			
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2			
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	_			
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330 Ω CS=150pF 10 times				

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

10.Backlight Information

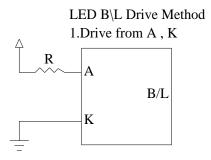
Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	15	40	60	mA	V=5.0V(Note 1)
Supply Voltage	V	_	5.0	_	V	_
Reverse Voltage	VR	_	_	5	V	_
Colour	X	0.26	_	0.32	_	_
Coordinate	Y	0.26	_	0.32	_	_
Luminance (Without LCD)	IV	800	1000	_	cd/m ²	ILED=40mA
LED Life Time (For Reference only)	_	_	50K	_	Hr.	ILED=40mA 25°C,50-60%RH, (Note 2)
Color	White				l	<u> </u>

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1: Supply current minimum value is only for reference since LED brightness efficiency keeps enhancing. Current consumption becomes less and less to achieve the same luminance.

Note 2:50K hours is only an estimate for reference.



11.Inspection specification

Item			Criterion		AQL
Electrical Testing	Missing vertical, horizontal segment, segment contrast defect. Missing character, dot or icon. Display malfunction. No function or no display. Current consumption exceeds product specifications. LCD viewing angle defect. Mixed product types. Contrast defect.				0.65
Black or white spots on LCD (display only)	three white or bl	2.1 White and black spots on display ≤ 0.25 mm, no more than three white or black spots present.			
LCD black spots, white spots, contamination (non-display)	3.1 Round type : As follow $\Phi = (x + y) / 2$ $X \qquad Y$ $Y \qquad Y$ 3.2 Line type : (As follow $Length$ $L \leq 3.0$		SizeAcceptable QTY $\Phi \le 0.10$ Accept no dense $0.10 < \Phi \le 0.20$ 2 $0.20 < \Phi \le 0.25$ 1 $0.25 < \Phi$ 0ving drawing)Acceptable Q TY $W \le 0.02$ Accept no dense $0.02 < W \le 0.03$ 2		2.5
Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.		0.05 < W Size Φ Φ≤0.20 0.20 < Φ≤0.50 0.50 < Φ≤1.00 1.00 < Φ	As round type Acceptable Q TY Accept no dense 3 2 0	2.5
	Electrical Testing Black or white spots on LCD (display only) LCD black spots, white spots, contamination (non-display)	Missing vertical, Missing characted Display malfunct No function or n Current consump LCD viewing an Mixed product to Contrast defect. Black or white spots on LCD (display only) 2.2 Densely space 3.1 Round type: Φ=(x+y)/2 ΔX LCD black spots, white spots, contamination (non-display) 3.2 Line type: (A If bubbles are vijudge using black specifications, not to find, must chesses the specifications of the find, must chesses the specification of the find of the fin	Missing vertical, horizont Missing character, dot or Display malfunction. No function or no display Current consumption executed LCD viewing angle defect Mixed product types. Contrast defect. Black or white spots on LCD (display only) 3.1 Round type: As follow Φ=(x+y)/2 LCD black spots, white spots, contamination (non-display) 3.2 Line type: (As follow Length L≤2.5 − If bubbles are visible, judge using black spot specifications, not easy to find, must check in	Missing vertical, horizontal segment, segment Missing character , dot or icon. Display malfunction. No function or no display. Current consumption exceeds product specific LCD viewing angle defect. Mixed product types. Contrast defect. Black or white spots on LCD (display only) 2.2 Densely spaced: No more than two spots of three white or black spots present. 2.2 Densely spaced: No more than two spots of three white spots, contamination (non-display) 3.1 Round type : As following drawing $\Phi = (x + y)/2$ $\frac{X}{T} = \frac{X}{T} = \frac{X}{$	Missing vertical, horizontal segment, segment contrast defect. Missing character , dot or icon. Display malfunction. No function or no display. Current consumption exceeds product specifications. LCD viewing angle defect. Mixed product types. Contrast defect. Black or white spots on LCD (display only) 2.1 White and black spots on display ≤ 0.25 mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 3.1 Round type : As following drawing

No	Item		Criterion		AQL
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination			
06	Chipped glass	k: Seal width t: L: Electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surf z: Chip thickness $Z \le 1/2t$ $1/2t < z \le 2t$	Glass thickness a: LC:	$x: Chip length$ $x \le 1/8a$ $x \le 1/8a$	2.5
		z: Chip thickness	y: Chip width	x: Chip length	
		Z≤1/2t	Not over viewing area	x ≤ 1/8a	
		$1/2t < z \leq 2t$	Not exceed 1/3k	x≤1/8a	
⊙ If there are 2 or more chips, x is the total length of each chip.					

No	Item	Criterion					
No	Glass	remain and be inspe	y: Chip width t: Glass thickness gth terminal: ode pad: x : Chip le $x \le 1/3$ x : Chip le $x \le 1/3$ at touches the ITO cted according to a be heat sealed by	z: Chip to sa: LCD sa a: L	chickness side length $ \begin{array}{c} \textbf{z: Chip thickness} \\ 0 < z \leq t \end{array} $ $ \begin{array}{c} \textbf{z: Chip thickness} \\ 0 < z \leq t \end{array} $ $ \begin{array}{c} \textbf{z: Chip thickness} \\ \text{o and } z \leq t \end{array} $ $ \begin{array}{c} \textbf{z: Chip thickness} \\ \textbf{o and } z \leq t \end{array} $ $ \begin{array}{c} \textbf{o and } z \leq t \end{array} $ $ \begin{array}{c} \textbf{o and } z \leq t \end{array} $ $ \begin{array}{c} \textbf{o and } z \leq t \end{array} $ $ \begin{array}{c} \textbf{o and } z \leq t \end{array} $ $ \begin{array}{c} \textbf{o and } z \leq t \end{array} $ $ \begin{array}{c} \textbf{o and } z \leq t $ $ \begin{array}{c} \textbf{o and } z \leq t \end{array} $ $ \begin{array}{c} \textbf{o and } z \leq t $ $ \begin{array}{c} \textbf{o and } z \leq t \end{array} $ $ \begin{array}{c} \textbf{o and } z \leq t $	2.5	

No	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
		8.1 Illumination source flickers when lit.	0.65
0.0	08 Backlight elements	8.2 Spots or scratched that appear when lit must be judged. Using	2.5
08		LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or	2.5
		contamination.	
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the seal	
		area on the PCB. And there should be no more than three places.	
		10.5 No oxidation or contamination PCB terminals.	
		10.6 Parts on PCB must be the same as on the production	2.5
10	PCB · COB	characteristic chart. There should be no wrong parts, missing parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product	
		characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	
		screw hold pad, make sure it is smoothed down.	2.5
		10.9 The Scraping testing standard for Copper Coating of PCB	
		\mathbf{X}	2.5
		$X * Y \leq 2mm^2$	
		11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections, oxidation	
11	Soldering	or icicle.	
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface Pin	2.5
		(OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin	2.5
	General	must be present or look as if it cause the interface pin to sever.	
		12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for

RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm
Above limited value is set up according to RoHS.										

2. Process for RoHS requirement : (only for RoHS inspection)

(1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.

(2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

le Number: Panel Specification:			Page: 1
Panel Type:	Pass	□ NG ,	
View Direction:	☐ Pass	□ NG ,	
Numbers of Dots:	☐ Pass	□ NG ,	
View Area:	☐ Pass	☐ NG ,	
Active Area:	☐ Pass	□ NG ,	
Operating Temperature :	Pass	□ NG ,	
Storage Temperature:	☐ Pass	□ NG ,	
Others:	_	<u> </u>	
Mechanical Specification:			
PCB Size:	Pass	□ NG ,	
Frame Size:	Pass	□ NG ,	
Materal of Frame:	Pass	☐ NG ,	
Connector Position:	Pass	□ NG ,	
Fix Hole Position:	Pass	□ NG ,	
Backlight Position:	Pass	☐ NG ,	
Thickness of PCB:	Pass	□ NG ,	
Height of Frame to PCB:	Pass	□ NG ,	
Height of Module:	Pass	□ NG ,	
Others:	☐ Pass	□ NG ,	
elative Hole Size:			
Pitch of Connector:	Pass	□ NG ,	
Hole size of Connector:	Pass	☐ NG ,	
Mounting Hole size:	Pass	☐ NG ,	
Mounting Hole Type:	Pass	☐ NG ,	
Others:	Pass	☐ NG ,	
acklight Specification:			
B/L Type:	Pass	□ NG ,	
B/L Color:	☐ Pass	□ NG ,	
3/L Driving Voltage (Refere	nce for LED 7	Type): Pass	☐ NG ,_
B/L Driving Current:	☐ Pass	□ NG ,	
Brightness of B/L:	☐ Pass	□ NG ,	
B/L Solder Method:	☐ Pass	□ NG ,	
Others:	☐ Pass	□ NG ,	



	winstar		
Modu	le Number :		Page: 2
5 、	Electronic Characteristics of	Module:	
1.	Input Voltage:	Pass	□ NG ,
2.	Supply Current:	Pass	□ NG ,
3.	Driving Voltage for LCD:	☐ Pass	□ NG ,
4.	Contrast for LCD:	☐ Pass	□ NG ,
5.	B/L Driving Method:	☐ Pass	□ NG ,
6.	Negative Voltage Output:	☐ Pass	□ NG ,
7.	Interface Function:	Pass	□ NG ,
8.	LCD Uniformity:	☐ Pass	□ NG ,
9.	ESD test:	☐ Pass	□ NG ,
10.	Others:	☐ Pass	□ NG ,
6、	Summary :		
	Sales signature :		
	Customer Signature:		Date: / /